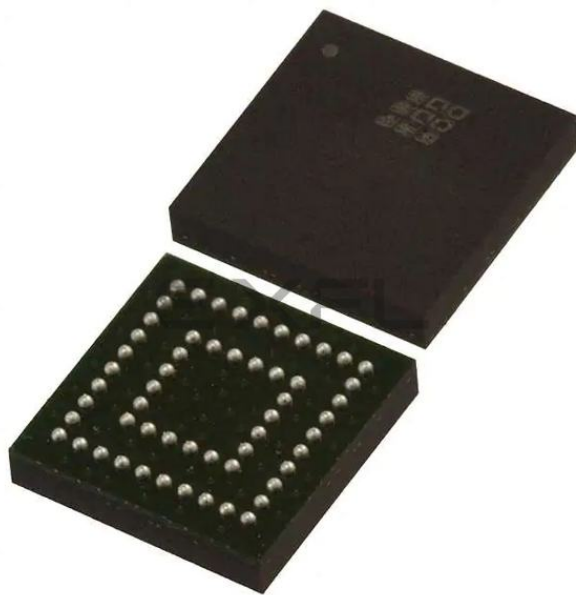




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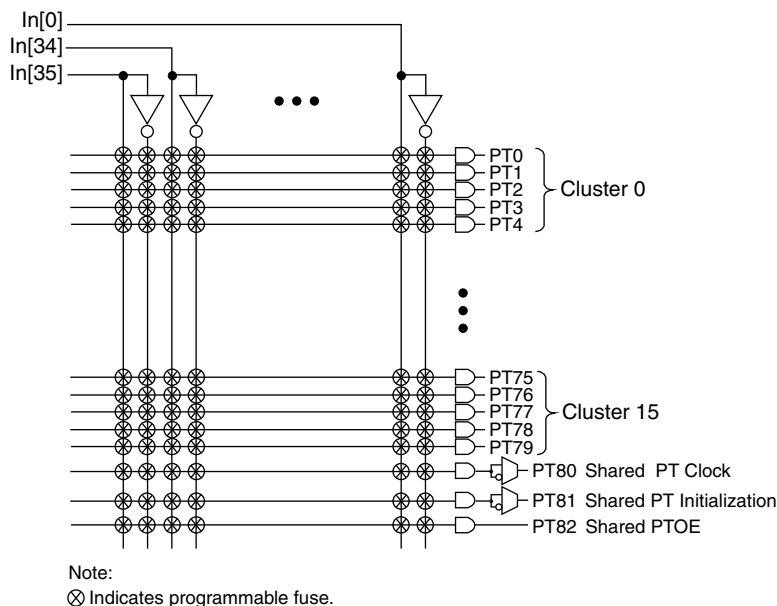
Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	3.5 ns
Voltage Supply - Internal	1.7V ~ 1.9V
Number of Logic Elements/Blocks	2
Number of Macrocells	32
Number of Gates	-
Number of I/O	32
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	56-LFBGA, CSPBGA
Supplier Device Package	56-CSBGA (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4032zc-35m56c

Figure 3. AND Array

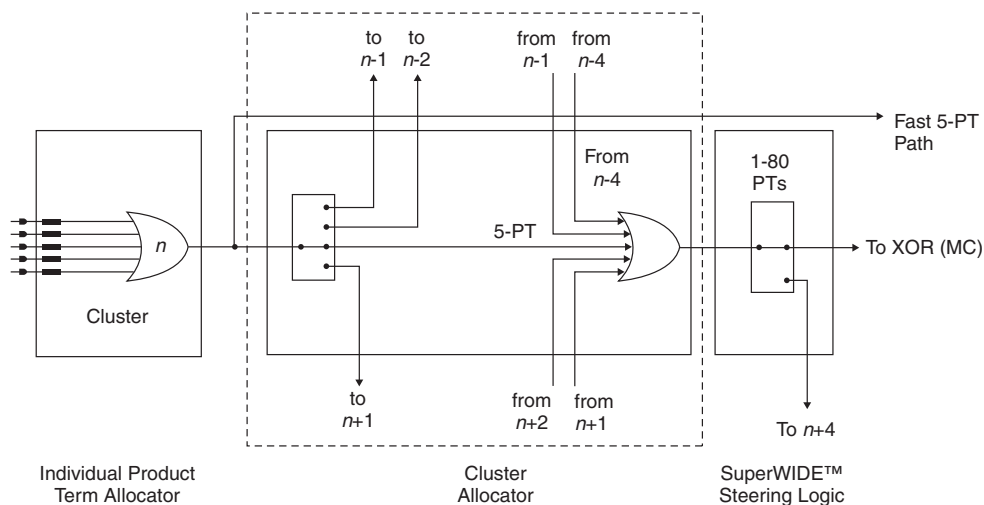
Enhanced Logic Allocator

Within the logic allocator, product terms are allocated to macrocells in product term clusters. Each product term cluster is associated with a macrocell. The cluster size for the ispMACH 4000 family is 4+1 (total 5) product terms. The software automatically considers the availability and distribution of product term clusters as it fits the functions within a GLB. The logic allocator is designed to provide three speed paths: 5-PT fast bypass path, 20-PT Speed Locking path and an up to 80-PT path. The availability of these three paths lets designers trade timing variability for increased performance.

The enhanced Logic Allocator of the ispMACH 4000 family consists of the following blocks:

- Product Term Allocator
- Cluster Allocator
- Wide Steering Logic

Figure 4 shows a macrocell slice of the Logic Allocator. There are 16 such slices in the GLB.

Figure 4. Macrocell Slice

Product Term Allocator

The product term allocator assigns product terms from a cluster to either logic or control applications as required by the design being implemented. Product terms that are used as logic are steered into a 5-input OR gate associated with the cluster. Product terms that used for control are steered either to the macrocell or I/O cell associated with the cluster. Table 3 shows the available functions for each of the five product terms in the cluster. The OR gate output connects to the associated I/O cell, providing a fast path for narrow combinatorial functions, and to the logic allocator.

Table 3. Individual PT Steering

Product Term	Logic	Control
PT n	Logic PT	Single PT for XOR/OR
PT $n+1$	Logic PT	Individual Clock (PT Clock)
PT $n+2$	Logic PT	Individual Initialization or Individual Clock Enable (PT Initialization/CE)
PT $n+3$	Logic PT	Individual Initialization (PT Initialization)
PT $n+4$	Logic PT	Individual OE (PTOE)

Cluster Allocator

The cluster allocator allows clusters to be steered to neighboring macrocells, thus allowing the creation of functions with more product terms. Table 4 shows which clusters can be steered to which macrocells. Used in this manner, the cluster allocator can be used to form functions of up to 20 product terms. Additionally, the cluster allocator accepts inputs from the wide steering logic. Using these inputs, functions up to 80 product terms can be created.

Table 4. Available Clusters for Each Macrocell

Macrocell	Available Clusters			
M0	—	C0	C1	C2
M1	C0	C1	C2	C3
M2	C1	C2	C3	C4
M3	C2	C3	C4	C5
M4	C3	C4	C5	C6
M5	C4	C5	C6	C7
M6	C5	C6	C7	C8
M7	C6	C7	C8	C9
M8	C7	C8	C9	C10
M9	C8	C9	C10	C11
M10	C9	C10	C11	C12
M11	C10	C11	C12	C13
M12	C11	C12	C13	C14
M13	C12	C13	C14	C15
M14	C13	C14	C15	—
M15	C14	C15	—	—

Wide Steering Logic

The wide steering logic allows the output of the cluster allocator n to be connected to the input of the cluster allocator $n+4$. Thus, cluster chains can be formed with up to 80 product terms, supporting wide product term functions and allowing performance to be increased through a single GLB implementation. Table 5 shows the product term chains.

Table 7. ORP Combinations for I/O Blocks with 16 I/Os

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M1, M2, M3, M4, M5, M6, M7, M8
I/O 2	M2, M3, M4, M5, M6, M7, M8, M9
I/O 3	M3, M4, M5, M6, M7, M8, M9, M10
I/O 4	M4, M5, M6, M7, M8, M9, M10, M11
I/O 5	M5, M6, M7, M8, M9, M10, M11, M12
I/O 6	M6, M7, M8, M9, M10, M11, M12, M13
I/O 7	M7, M8, M9, M10, M11, M12, M13, M14
I/O 8	M8, M9, M10, M11, M12, M13, M14, M15
I/O 9	M9, M10, M11, M12, M13, M14, M15, M0
I/O 10	M10, M11, M12, M13, M14, M15, M0, M1
I/O 11	M11, M12, M13, M14, M15, M0, M1, M2
I/O 12	M12, M13, M14, M15, M0, M1, M2, M3
I/O 13	M13, M14, M15, M0, M1, M2, M3, M4
I/O 14	M14, M15, M0, M1, M2, M3, M4, M5
I/O 15	M15, M0, M1, M2, M3, M4, M5, M6

Table 8. ORP Combinations for I/O Blocks with 4 I/Os

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M4, M5, M6, M7, M8, M9, M10, M11
I/O 2	M8, M9, M10, M11, M12, M13, M14, M15
I/O 3	M12, M13, M14, M15, M0, M1, M2, M3

Table 9. ORP Combinations for I/O Blocks with 10 I/Os

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M2, M3, M4, M5, M6, M7, M8, M9
I/O 2	M4, M5, M6, M7, M8, M9, M10, M11
I/O 3	M6, M7, M8, M9, M10, M11, M12, M13
I/O 4	M8, M9, M10, M11, M12, M13, M14, M15
I/O 5	M10, M11, M12, M13, M14, M15, M0, M1
I/O 6	M12, M13, M14, M15, M0, M1, M2, M3
I/O 7	M14, M15, M0, M1, M2, M3, M4, M5
I/O 8	M2, M3, M4, M5, M6, M7, M8, M9
I/O 9	M10, M11, M12, M13, M14, M15, M0, M1

Table 10. ORP Combinations for I/O Blocks with 12 I/Os

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M1, M2, M3, M4, M5, M6, M7, M8
I/O 2	M2, M3, M4, M5, M6, M7, M8, M9
I/O 3	M4, M5, M6, M7, M8, M9, M10, M11
I/O 4	M5, M6, M7, M8, M9, M10, M11, M12
I/O 5	M6, M7, M8, M9, M10, M11, M12, M13
I/O 6	M8, M9, M10, M11, M12, M13, M14, M15
I/O 7	M9, M10, M11, M12, M13, M14, M15, M0
I/O 8	M10, M11, M12, M13, M14, M15, M0, M1
I/O 9	M12, M13, M14, M15, M0, M1, M2, M3
I/O 10	M13, M14, M15, M0, M1, M2, M3, M4
I/O 11	M14, M15, M0, M1, M2, M3, M4, M5

ORP Bypass and Fast Output Multiplexers

The ORP bypass and fast-path output multiplexer is a 4:1 multiplexer and allows the 5-PT fast path to bypass the ORP and be connected directly to the pin with either the regular output or the inverted output. This multiplexer also allows the register output to bypass the ORP to achieve faster t_{CO} .

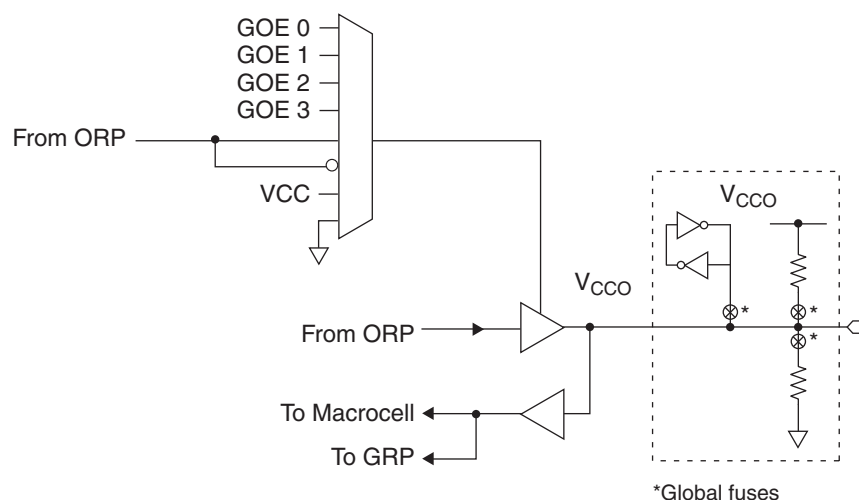
Output Enable Routing Multiplexers

The OE Routing Pool provides the corresponding local output enable (OE) product term to the I/O cell.

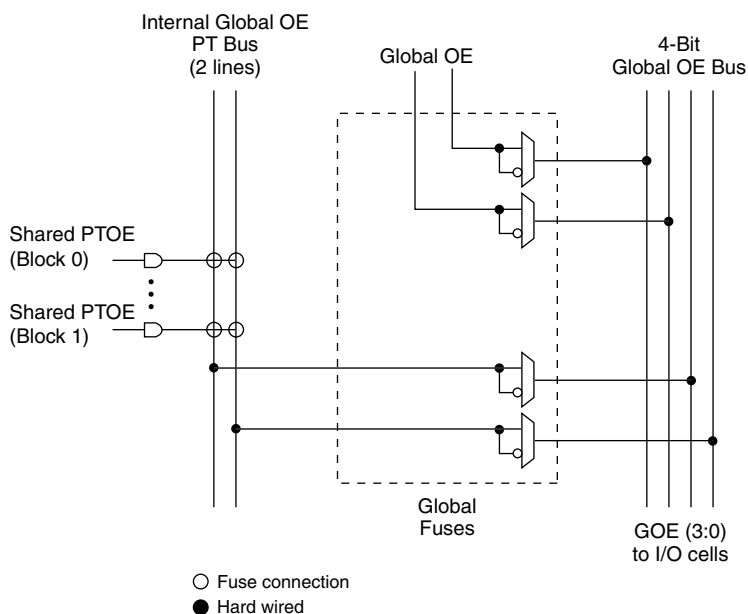
I/O Cell

The I/O cell contains the following programmable elements: output buffer, input buffer, OE multiplexer and bus maintenance circuitry. Figure 8 details the I/O cell.

Figure 8. I/O Cell



Each output supports a variety of output standards dependent on the V_{CCO} supplied to its I/O bank. Outputs can also be configured for open drain operation. Each input can be programmed to support a variety of standards, independent of the V_{CCO} supplied to its I/O bank. The I/O standards supported are:

Figure 10. Global OE Generation for ispMACH 4032

Zero Power/Low Power and Power Management

The ispMACH 4000 family is designed with high speed low power design techniques to offer both high speed and low power. With an advanced E^2 low power cell and non sense-amplifier design approach (full CMOS logic approach), the ispMACH 4000 family offers SuperFAST pin-to-pin speeds, while simultaneously delivering low standby power without needing any “turbo bits” or other power management schemes associated with a traditional sense-amplifier approach.

The zero power ispMACH 4000Z is based on the 1.8V ispMACH 4000C family. With innovative circuit design changes, the ispMACH 4000Z family is able to achieve the industry’s “lowest static power”.

IEEE 1149.1-Compliant Boundary Scan Testability

All ispMACH 4000 devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port operates with an LVCMOS interface that corresponds to the power supply voltage.

I/O Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os’ physical nature should be minimal so that board test time is minimized. The ispMACH 4000 family of devices allows this by offering the user the ability to quickly configure the physical nature of the I/O cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice’s ispVM® System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

Supply Current, ispMACH 4000V/B/C (Cont.)

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{CC}^{4}	Standby Power Supply Current	$V_{CC} = 3.3V$	—	13	—	mA
		$V_{CC} = 2.5V$	—	13	—	mA
		$V_{CC} = 1.8V$	—	3	—	mA

1. $T_A = 25^{\circ}C$, frequency = 1.0 MHz.
2. Device configured with 16-bit counters.
3. I_{CC} varies with specific device configuration and operating frequency.
4. $T_A = 25^{\circ}C$

Supply Current, ispMACH 4000Z

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
ispMACH 4032ZC						
ICC ^{1, 2, 3, 5}	Operating Power Supply Current	Vcc = 1.8V, T _A = 25°C	—	50	—	μA
		Vcc = 1.9V, T _A = 70°C	—	58	—	μA
		Vcc = 1.9V, T _A = 85°C	—	60	—	μA
		Vcc = 1.9V, T _A = 125°C	—	70	—	μA
ICC ^{4, 5}	Standby Power Supply Current	Vcc = 1.8V, T _A = 25°C	—	10	—	μA
		Vcc = 1.9V, T _A = 70°C	—	13	20	μA
		Vcc = 1.9V, T _A = 85°C	—	15	25	μA
		Vcc = 1.9V, T _A = 125°C	—	22	—	μA
ispMACH 4064ZC						
ICC ^{1, 2, 3, 5}	Operating Power Supply Current	Vcc = 1.8V, T _A = 25°C	—	80	—	μA
		Vcc = 1.9V, T _A = 70°C	—	89	—	μA
		Vcc = 1.9V, T _A = 85°C	—	92	—	μA
		Vcc = 1.9V, T _A = 125°C	—	109	—	μA
ICC ^{4, 5}	Standby Power Supply Current	Vcc = 1.8V, T _A = 25°C	—	11	—	μA
		Vcc = 1.9V, T _A = 70°C	—	15	25	μA
		Vcc = 1.9V, T _A = 85°C	—	18	35	μA
		Vcc = 1.9V, T _A = 125°C	—	37	—	μA
ispMACH 4128ZC						
ICC ^{1, 2, 3, 5}	Operating Power Supply Current	Vcc = 1.8V, T _A = 25°C	—	168	—	μA
		Vcc = 1.9V, T _A = 70°C	—	190	—	μA
		Vcc = 1.9V, T _A = 85°C	—	195	—	μA
		Vcc = 1.9V, T _A = 125°C	—	212	—	μA
ICC ^{4, 5}	Standby Power Supply Current	Vcc = 1.8V, T _A = 25°C	—	12	—	μA
		Vcc = 1.9V, T _A = 70°C	—	16	35	μA
		Vcc = 1.9V, T _A = 85°C	—	19	50	μA
		Vcc = 1.9V, T _A = 125°C	—	42	—	μA

ispMACH 4000Z External Switching Characteristics (Cont.)**Over Recommended Operating Conditions**

Parameter	Description ^{1, 2, 3}	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{PD}	5-PT bypass combinatorial propagation delay	—	4.5	—	5.0	—	7.5	ns
t_{PD_MC}	20-PT combinatorial propagation delay through macrocell	—	5.8	—	6.0	—	8.0	ns
t_S	GLB register setup time before clock	2.9	—	3.0	—	4.5	—	ns
t_{ST}	GLB register setup time before clock with T-type register	3.1	—	3.2	—	4.7	—	ns
t_{SIR}	GLB register setup time before clock, input register path	1.3	—	1.3	—	1.4	—	ns
t_{SIRZ}	GLB register setup time before clock with zero hold	2.6	—	2.6	—	2.7	—	ns
t_H	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t_{HT}	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t_{HIR}	GLB register hold time after clock, input register path	1.3	—	1.3	—	1.3	—	ns
t_{HIRZ}	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t_{CO}	GLB register clock-to-output delay	—	3.8	—	4.2	—	4.5	ns
t_R	External reset pin to output delay	—	7.5	—	7.5	—	9.0	ns
t_{RW}	External reset pulse duration	2.0	—	2.0	—	4.0	—	ns
$t_{PTOE/DIS}$	Input to output local product term output enable/disable	—	8.2	—	8.5	—	9.0	ns
$t_{GPTOE/DIS}$	Input to output global product term output enable/disable	—	10.0	—	10.0	—	10.5	ns
$t_{GOE/DIS}$	Global OE input to output enable/disable	—	5.5	—	6.0	—	7.0	ns
t_{CW}	Global clock width, high or low	1.8	—	2.0	—	2.8	—	ns
t_{GW}	Global gate width low (for low transparent) or high (for high transparent)	1.8	—	2.0	—	2.8	—	ns
t_{WIR}	Input register clock width, high or low	1.8	—	2.0	—	2.8	—	ns
f_{MAX}^4	Clock frequency with internal feedback	—	200	—	200	—	168	MHz
$f_{MAX} (Ext.)$	clock frequency with external feedback, $[1 / (t_S + t_{CO})]$	—	150	—	139	—	111	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.2.2

2. Measured using standard switching GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

ispMACH 4000V/B/C Internal Timing Parameters

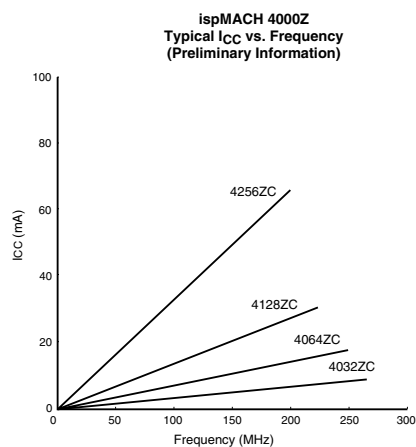
Over Recommended Operating Conditions

Parameter	Description	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
In/Out Delays								
t _{IN}	Input Buffer Delay	—	0.95	—	1.50	—	2.00	ns
t _{GOE}	Global OE Pin Delay	—	4.04	—	6.04	—	7.04	ns
t _{GCLK_IN}	Global Clock Input Buffer Delay	—	1.83	—	2.28	—	3.28	ns
t _{BUF}	Delay through Output Buffer	—	1.00	—	1.50	—	1.50	ns
t _{EN}	Output Enable Time	—	0.96	—	0.96	—	0.96	ns
t _{DIS}	Output Disable Time	—	0.96	—	0.96	—	0.96	ns
Routing/GLB Delays								
t _{ROUTE}	Delay through GRP	—	1.51	—	2.26	—	3.26	ns
t _{MCELL}	Macrocell Delay	—	1.05	—	1.45	—	1.95	ns
t _{INREG}	Input Buffer to Macrocell Register Delay	—	0.56	—	0.96	—	1.46	ns
t _{FBK}	Internal Feedback Delay	—	0.00	—	0.00	—	0.00	ns
t _{PDb}	5-PT Bypass Propagation Delay	—	1.54	—	2.24	—	3.24	ns
t _{PDi}	Macrocell Propagation Delay	—	0.94	—	1.24	—	1.74	ns
Register/Latch Delays								
t _S	D-Register Setup Time (Global Clock)	1.32	—	1.57	—	1.57	—	ns
t _{S_PT}	D-Register Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
t _{ST}	T-Register Setup Time (Global Clock)	1.52	—	1.77	—	1.77	—	ns
t _{ST_PT}	T-Register Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
t _H	D-Register Hold Time	1.68	—	2.93	—	3.93	—	ns
t _{HT}	T-Register Hold Time	1.68	—	2.93	—	3.93	—	ns
t _{SIR}	D-Input Register Setup Time (Global Clock)	1.52	—	1.57	—	1.57	—	ns
t _{SIR_PT}	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
t _{HIR}	D-Input Register Hold Time (Global Clock)	0.68	—	1.18	—	1.18	—	ns
t _{HIR_PT}	D-Input Register Hold Time (Product Term Clock)	0.68	—	1.18	—	1.18	—	ns
t _{COi}	Register Clock to Output/Feedback MUX Time	—	0.52	—	0.67	—	1.17	ns
t _{CES}	Clock Enable Setup Time	2.25	—	2.25	—	2.25	—	ns
t _{CEH}	Clock Enable Hold Time	1.88	—	1.88	—	1.88	—	ns
t _{SL}	Latch Setup Time (Global Clock)	1.32	—	1.57	—	1.57	—	ns
t _{SL_PT}	Latch Setup Time (Product Term Clock)	1.32	—	1.32	—	1.32	—	ns
t _{HL}	Latch Hold Time	1.17	—	1.17	—	1.17	—	ns
t _{GOi}	Latch Gate to Output/Feedback MUX Time	—	0.33	—	0.33	—	0.33	ns
t _{PDLi}	Propagation Delay through Transparent Latch to Output/ Feedback MUX	—	0.25	—	0.25	—	0.25	ns
t _{SRI}	Asynchronous Reset or Set to Output/Feedback MUX Delay	0.28	—	0.28	—	0.28	—	ns
t _{SRR}	Asynchronous Reset or Set Recovery Time	1.67	—	1.67	—	1.67	—	ns
Control Delays								
t _{BCLK}	GLB PT Clock Delay	—	1.12	—	1.12	—	0.62	ns
t _{PTCLK}	Macrocell PT Clock Delay	—	0.87	—	0.87	—	0.87	ns
t _{BSR}	GLB PT Set/Reset Delay	—	1.83	—	1.83	—	1.83	ns
t _{PTSR}	Macrocell PT Set/Reset Delay	—	2.51	—	3.41	—	3.41	ns

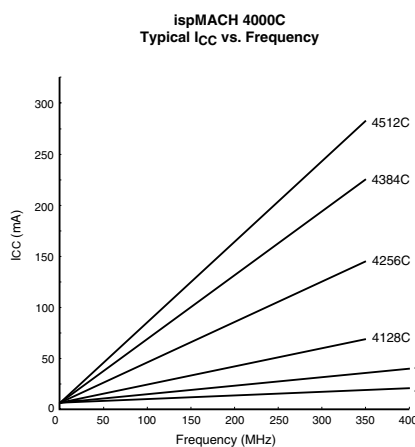
Boundary Scan Waveforms and Timing Specifications

Symbol	Parameter	Min.	Max.	Units
t_{BTCP}	TCK [BSCAN test] clock cycle	40	—	ns
t_{BTCH}	TCK [BSCAN test] pulse width high	20	—	ns
t_{BTCL}	TCK [BSCAN test] pulse width low	20	—	ns
t_{BTSU}	TCK [BSCAN test] setup time	8	—	ns
t_{BTH}	TCK [BSCAN test] hold time	10	—	ns
t_{BRF}	TCK [BSCAN test] rise and fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
t_{BTOZ}	TAP controller falling edge of clock to data output disable	—	10	ns
t_{BTVO}	TAP controller falling edge of clock to data output enable	—	10	ns
t_{BTCPSU}	BSCAN test Capture register setup time	8	—	ns
t_{BTCPH}	BSCAN test Capture register hold time	10	—	ns
t_{BTUCO}	BSCAN test Update reg, falling edge of clock to valid output	—	25	ns
t_{BTUOZ}	BSCAN test Update reg, falling edge of clock to output disable	—	25	ns
t_{BTUOV}	BSCAN test Update reg, falling edge of clock to output enable	—	25	ns

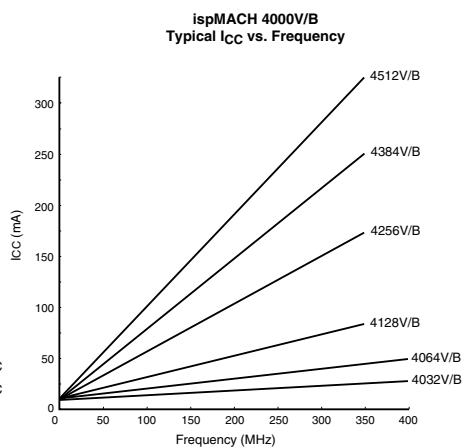
Power Consumption



Note: The devices are configured with maximum number of 16-bit counters, typical current at 1.8V, 25°C.



Note: The devices are configured with maximum number of 16-bit counters, typical current at 1.8V, 25°C.



Note: The devices are configured with maximum number of 16-bit counters, typical current at 3.3V, 2.5V, 25°C.

Power Estimation Coefficients¹

Device	A	B
ispMACH 4032V/B	11.3	0.010
ispMACH 4032C	1.3	0.010
ispMACH 4064V/B	11.5	0.010
ispMACH 4064C	1.5	0.010
ispMACH 4128V/B	11.5	0.011
ispMACH 4128C	1.5	0.011
ispMACH 4256V/B	12	0.011
ispMACH 4256C	2	0.011
ispMACH 4384V/B	12.5	0.013
ispMACH 4384C	2.5	0.013
ispMACH 4512V/B	13	0.013
ispMACH 4512C	3	0.013
ispMACH 4032ZC	0.010	0.010
ispMACH 4064ZC	0.011	0.010
ispMACH 4128ZC	0.012	0.010
ispMACH 4256ZC	0.013	0.010

1. For further information about the use of these coefficients, refer to TN1005, [Power Estimation in ispMACH 4000V/B/C/Z Devices](#).

ispMACH 4000V/B/C/Z Power Supply and NC Connections¹ (Cont.)

Signal	132-ball csBGA ⁷	144-pin TQFP ⁴	176-pin TQFP ⁴	256-ball ftBGA/fpBGA ^{2,3,7,9}
VCC	P1, A14, B7, N8	36, 57, 108, 129	42, 69, 88, 130, 157, 176	B2, B15, G8, G9, K8, K9, R2, R15
VCCO0 VCCO (Bank 0)	G3, P5, C1 ⁸ , M2 ⁸ , C5	3, 19, 34, 47, 136	4, 22, 40, 56, 166	D6, F4, H7, J7, L4, N6
VCCO1 VCCO (Bank 1)	M10, M14 ⁸ , H12, A10, C13 ⁸	64, 75, 91, 106, 119	78, 92, 110, 128, 144	D11, F13, H10, J10, L13, N11
GND	B1, P2, N14, A13	1, 37, 73, 109	2, 46 ⁵ , 65, 90, 134, 153	A1, A16, C6, C11, F3, F14, G7, G10, H8, H9, J8, J9, K7, K10, L3, L14, P6, P11, T1, T16
GND (Bank 0)	E2, K2, N4, B4	10, 18 ⁶ , 27, 46, 127, 137	13, 31, 55, 155, 167	
GND (Bank 1)	N11, K13, E13, B11	55, 65, 82, 90 ⁶ , 99, 118	67, 79, 101, 119, 143	
NC	4064Z: C1, C3, E1, E3, H2, J3, K1, M2, M4, N5, P7, P8, M8, P10, P11, P14, M12, K14, K12, G13, G14, E14, C13, B13, B10, C10, A7, B5, A5, A4, A1 4128Z: P8, A7	4128V: 17, 20, 38, 45, 72, 89, 92, 110, 117, 144 4256V: 18, 90	1, 43, 44, 45, 89, 131, 132, 133	4256V/B/C, 128 I/O: A4, A5, A6, A11, A12, A13, A15, B5, B6, B11, B12, B14, C7, D1, D4, D5, D10, D12, D16, E1, E2, E4, E5, E7, E10, E13, E14, E15, E16, F1, F2, F15, F16, G1, G4, G5, G6, G12, G13, G14, J11, K3, K4, K15, L1, L2, L12, L15, L16, M1, M2, M3, M4, M5, M12, M13, M15, M16, N1, N2, N7, N10, N12, N14, P5, P12, R4, R5, R6, R11, R12, R16, T2, T4, T5, T6, T11, T12, T13, T15 4256V/B/C, 160 I/O: A5, A12, A15, B5, B6, B11, B12, B14, D4, D5, D12, E1, E4, E5, E13, E15, E16, F1, F2, F15, G1, G5, G12, G14, L1, L2, L12, L15, L16, M1, M2, M3, M12, M16, N1, N12, N14, P5, R4, R5, R6, R11, R12, R16, T4, T5, T12, T15 4384V/B/C: B5, B12, D5, D12, E1, E15, E16, F2, L12, M1, M2, M16, N12, R5, R12, T4 4512V/B/C: None

1. All grounds must be electrically connected at the board level. However, for the purposes of I/O current loading, grounds are associated with the bank shown.
2. Internal GNDs and I/O GNDs (Bank 0/1) are connected inside package.
3. VCCO balls connect to two power planes within the package, one for VCCO0 and one for VCCO1.
4. Pin orientation follows the conventional order from pin 1 marking of the top side view and counter-clockwise.
5. ispMACH 4384V/B/C pin 46 is tied to GND (Bank 0).
6. ispMACH 4128V only.
7. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.
8. ispMACH 4128Z and 4256Z only. NC for ispMACH 4064Z.
9. Use 256 ftBGA package for all new designs. Refer to PCN#14A-07 for 256 fpBGA package discontinuance.

**ispMACH 4032V/B/C/Z and 4064V/B/C/Z Logic Signal Connections:
48-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4032V/B/C/Z		ispMACH 4064V/B/C		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
33	1	B10	B [^] 10	D4	D [^] 2	D10	D [^] 5
34	1	B11	B [^] 11	D6	D [^] 3	D8	D [^] 4
35	-	TDO	-	TDO	-	TDO	-
36	-	VCC	-	VCC	-	VCC	-
37	-	GND	-	GND	-	GND	-
38	1	B12	B [^] 12	D8	D [^] 4	D6	D [^] 3
39	1	B13	B [^] 13	D10	D [^] 5	D4	D [^] 2
40	1	B14	B [^] 14	D12	D [^] 6	D2	D [^] 1
41	1	B15/GOE1	B [^] 15	D14/GOE1	D [^] 7	D0/GOE1	D [^] 0
42	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
43	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
44	0	A0/GOE0	A [^] 0	A0/GOE0	A [^] 0	A0/GOE0	A [^] 0
45	0	A1	A [^] 1	A2	A [^] 1	A1	A [^] 1
46	0	A2	A [^] 2	A4	A [^] 2	A2	A [^] 2
47	0	A3	A [^] 3	A6	A [^] 3	A4	A [^] 3
48	0	A4	A [^] 4	A8	A [^] 4	A6	A [^] 4

ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
B1	-	TDI	-	TDI	-
C3	0	A5	A [^] 5	A8	A [^] 5
C1	0	A6	A [^] 6	A10	A [^] 6
D1	0	A7	A [^] 7	A11	A [^] 7
D3	0	GND (Bank 0)	-	GND (Bank 0)	-
E3	0	NC ¹	-	I ¹	-
E1	0	NC ¹	-	I ¹	-
F3	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
F1	0	A8	A [^] 8	B15	B [^] 7
G3	0	A9	A [^] 9	B12	B [^] 6
G1	0	A10	A [^] 10	B10	B [^] 5
H1	0	A11	A [^] 11	B8	B [^] 4
J1	0	NC	-	I	-
K1	-	TCK	-	TCK	-
K2	-	VCC	-	VCC	-
H3	-	GND	-	GND	-
K3	-	NC ¹	-	I ¹	-
K4	0	A12	A [^] 12	B6	B [^] 3
H4	0	A13	A [^] 13	B4	B [^] 2
H5	0	A14	A [^] 14	B2	B [^] 1

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:
100-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
42	1	C1	C ¹	E2	E ¹	I6	I ¹
43	1	C2	C ²	E4	E ²	I10	I ²
44	1	C3	C ³	E6	E ³	I12	I ³
45	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
46	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
47	1	C4	C ⁴	E8	E ⁴	J2	J ⁰
48	1	C5	C ⁵	E10	E ⁵	J6	J ¹
49	1	C6	C ⁶	E12	E ⁶	J10	J ²
50	1	C7	C ⁷	E14	E ⁷	J12	J ³
51	-	GND	-	GND	-	GND	-
52	-	TMS	-	TMS	-	TMS	-
53	1	C8	C ⁸	F0	F ⁰	K12	K ³
54	1	C9	C ⁹	F2	F ¹	K10	K ²
55	1	C10	C ¹⁰	F4	F ²	K6	K ¹
56	1	C11	C ¹¹	F6	F ³	K2	K ⁰
57	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
58	1	C12	C ¹²	F8	F ⁴	L12	L ³
59	1	C13	C ¹³	F10	F ⁵	L10	L ²
60	1	C14	C ¹⁴	F12	F ⁶	L6	L ¹
61	1	C15	C ¹⁵	F13	F ⁷	L4	L ⁰
62*	1	I	-	I	-	I	-
63	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
64	1	D15	D ¹⁵	G14	G ⁷	M4	M ⁰
65	1	D14	D ¹⁴	G12	G ⁶	M6	M ¹
66	1	D13	D ¹³	G10	G ⁵	M10	M ²
67	1	D12	D ¹²	G8	G ⁴	M12	M ³
68	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
69	1	D11	D ¹¹	G6	G ³	N2	N ⁰
70	1	D10	D ¹⁰	G5	G ²	N6	N ¹
71	1	D9	D ⁹	G4	G ¹	N10	N ²
72	1	D8	D ⁸	G2	G ⁰	N12	N ³
73*	1	I	-	I	-	I	-
74	-	TDO	-	TDO	-	TDO	-
75	-	VCC	-	VCC	-	VCC	-
76	-	GND	-	GND	-	GND	-
77*	1	I	-	I	-	I	-
78	1	D7	D ⁷	H13	H ⁷	O12	O ³
79	1	D6	D ⁶	H12	H ⁶	O10	O ²
80	1	D5	D ⁵	H10	H ⁵	O6	O ¹
81	1	D4	D ⁴	H8	H ⁴	O2	O ⁰
82	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:
132-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
E3	0	NC	-	B8	B^6	D12	D^6
F2	0	A12	A^12	B9	B^7	D10	D^5
F1	0	A13	A^13	B10	B^8	D8	D^4
F3	0	A14	A^14	B12	B^9	D6	D^3
G1	0	A15	A^15	B13	B^10	D4	D^2
G2	0	I	-	B14	B^11	D2	D^1
G3	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
H2	0	NC	-	C14	C^11	E2	E^1
H1	0	B15	B^15	C13	C^10	E4	E^2
H3	0	B14	B^14	C12	C^9	E6	E^3
J1	0	B13	B^13	C10	C^8	E8	E^4
J2	0	B12	B^12	C9	C^7	E10	E^5
J3	0	NC	-	C8	C^6	E12	E^6
K2	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
K1	0	NC	-	C6	C^5	F2	F^1
K3	0	B11	B^11	C5	C^4	F4	F^2
L2	0	B10	B^10	C4	C^3	F6	F^3
L1	0	B9	B^9	C2	C^2	F8	F^4
L3	0	B8	B^8	C1	C^1	F10	F^5
M1	0	I	-	C0	C^0	F12	F^6
M2	0	NC	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
N1	-	TCK	-	TCK	-	TCK	-
P1	-	VCC	-	VCC	-	VCC	-
P2	-	GND	-	GND	-	GND	-
N2	0	I	-	D14	D^11	G12	G^6
P3	0	B7	B^7	D13	D^10	G10	G^5
M3	0	B6	B^6	D12	D^9	G8	G^4
N3	0	B5	B^5	D10	D^8	G6	G^3
P4	0	B4	B^4	D9	D^7	G4	G^2
M4	0	NC	-	D8	D^6	G2	G^1
N4	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
P5	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
N5	0	NC	-	D6	D^5	H12	H^6
M5	0	B3	B^3	D5	D^4	H10	H^5
N6	0	B2	B^2	D4	D^3	H8	H^4
P6	0	B1	B^1	D2	D^2	H6	H^3
M6	0	B0	B^0	D1	D^1	H4	H^2
P7	0	NC	-	D0	D^0	H2	H^1
N7	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
M7	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
N8	-	VCC	-	VCC	-	VCC	-

ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP (Cont.)

Pin Number	Bank Number	ispMACH 4128V		ispMACH 4256V	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
43	0	D9	D [^] 7	G4	G [^] 2
44	0	D8	D [^] 6	G2	G [^] 1
45	0	NC ²	-	I ²	-
46	0	GND (Bank 0)	-	GND (Bank 0)	-
47	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
48	0	D6	D [^] 5	H12	H [^] 6
49	0	D5	D [^] 4	H10	H [^] 5
50	0	D4	D [^] 3	H8	H [^] 4
51	0	D2	D [^] 2	H6	H [^] 3
52	0	D1	D [^] 1	H4	H [^] 2
53	0	D0	D [^] 0	H2	H [^] 1
54	0	CLK1/I	-	CLK1/I	-
55	1	GND (Bank 1)	-	GND (Bank 1)	-
56	1	CLK2/I	-	CLK2/I	-
57	-	VCC	-	VCC	-
58	1	E0	E [^] 0	I2	I [^] 1
59	1	E1	E [^] 1	I4	I [^] 2
60	1	E2	E [^] 2	I6	I [^] 3
61	1	E4	E [^] 3	I8	I [^] 4
62	1	E5	E [^] 4	I10	I [^] 5
63	1	E6	E [^] 5	I12	I [^] 6
64	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
65	1	GND (Bank 1)	-	GND (Bank 1)	-
66	1	E8	E [^] 6	J2	J [^] 1
67	1	E9	E [^] 7	J4	J [^] 2
68	1	E10	E [^] 8	J6	J [^] 3
69	1	E12	E [^] 9	J8	J [^] 4
70	1	E13	E [^] 10	J10	J [^] 5
71	1	E14	E [^] 11	J12	J [^] 6
72	1	NC ²	-	I ²	-
73	-	GND	-	GND	-
74	-	TMS	-	TMS	-
75	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
76	1	F0	F [^] 0	K12	K [^] 6
77	1	F1	F [^] 1	K10	K [^] 5
78	1	F2	F [^] 2	K8	K [^] 4
79	1	F4	F [^] 3	K6	K [^] 3
80	1	F5	F [^] 4	K4	K [^] 2
81	1	F6	F [^] 5	K2	K [^] 1
82	1	GND (Bank 1)	-	GND (Bank 1)	-
83	1	F8	F [^] 6	L14	L [^] 7
84	1	F9	F [^] 7	L12	L [^] 6
85	1	F10	F [^] 8	L10	L [^] 5

ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP (Cont.)

Pin Number	Bank Number	ispMACH 4128V		ispMACH 4256V	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
129	-	VCC	-	VCC	-
130	0	A0/GOE0	A^0	A2/GOE0	A^1
131	0	A1	A^1	A4	A^2
132	0	A2	A^2	A6	A^3
133	0	A4	A^3	A8	A^4
134	0	A5	A^4	A10	A^5
135	0	A6	A^5	A12	A^6
136	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
137	0	GND (Bank 0)	-	GND (Bank 0)	-
138	0	A8	A^6	B2	B^1
139	0	A9	A^7	B4	B^2
140	0	A10	A^8	B6	B^3
141	0	A12	A^9	B8	B^4
142	0	A13	A^10	B10	B^5
143	0	A14	A^11	B12	B^6
144	0	NC ²	-	I ²	-

1. For device migration considerations, these NC pins are GND pins for I/O banks in ispMACH 4128V devices.

2. For device migration considerations, these NC pins are input signal pins in ispMACH 4256V devices.

ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections: 176-Pin TQFP

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	NC	-	NC	-	NC	-
2	-	GND	-	GND	-	GND	-
3	-	TDI	-	TDI	-	TDI	-
4	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
5	0	C14	C^7	C14	C^7	C14	C^7
6	0	C12	C^6	C12	C^6	C12	C^6
7	0	C10	C^5	C10	C^5	C10	C^5
8	0	C8	C^4	C8	C^4	C8	C^4
9	0	C6	C^3	C6	C^3	C6	C^3
10	0	C4	C^2	C4	C^2	C4	C^2
11	0	C2	C^1	C2	C^1	C2	C^1
12	0	C0	C^0	C0	C^0	C0	C^0
13	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
14	0	D14	D^7	E14	E^7	G14	G^7
15	0	D12	D^6	E12	E^6	G12	G^6
16	0	D10	D^5	E10	E^5	G10	G^5
17	0	D8	D^4	E8	E^4	G8	G^4
18	0	D6	D^3	E6	E^3	G6	G^3

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
19	0	D4	D [^] 2	E4	E [^] 2	G4	G [^] 2
20	0	D2	D [^] 1	E2	E [^] 1	G2	G [^] 1
21	0	D0	D [^] 0	E0	E [^] 0	G0	G [^] 0
22	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
23	0	E0	E [^] 0	H0	H [^] 0	J0	J [^] 0
24	0	E2	E [^] 1	H2	H [^] 1	J2	J [^] 1
25	0	E4	E [^] 2	H4	H [^] 2	J4	J [^] 2
26	0	E6	E [^] 3	H6	H [^] 3	J6	J [^] 3
27	0	E8	E [^] 4	H8	H [^] 4	J8	J [^] 4
28	0	E10	E [^] 5	H10	H [^] 5	J10	J [^] 5
29	0	E12	E [^] 6	H12	H [^] 6	J12	J [^] 6
30	0	E14	E [^] 7	H14	H [^] 7	J14	J [^] 7
31	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
32	0	F0	F [^] 0	J0	J [^] 0	N0	N [^] 0
33	0	F2	F [^] 1	J2	J [^] 1	N2	N [^] 1
34	0	F4	F [^] 2	J4	J [^] 2	N4	N [^] 2
35	0	F6	F [^] 3	J6	J [^] 3	N6	N [^] 3
36	0	F8	F [^] 4	J8	J [^] 4	N8	N [^] 4
37	0	F10	F [^] 5	J10	J [^] 5	N10	N [^] 5
38	0	F12	F [^] 6	J12	J [^] 6	N12	N [^] 6
39	0	F14	F [^] 7	J14	J [^] 7	N14	N [^] 7
40	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
41	-	TCK	-	TCK	-	TCK	-
42	-	VCC	-	VCC	-	VCC	-
43	-	NC	-	NC	-	NC	-
44	-	NC	-	NC	-	NC	-
45	-	NC	-	NC	-	NC	-
46	-	GND	-	GND (Bank 0)	-	GND	-
47	0	G14	G [^] 7	K14	K [^] 7	O14	O [^] 7
48	0	G12	G [^] 6	K12	K [^] 6	O12	O [^] 6
49	0	G10	G [^] 5	K10	K [^] 5	O10	O [^] 5
50	0	G8	G [^] 4	K8	K [^] 4	O8	O [^] 4
51	0	G6	G [^] 3	K6	K [^] 3	O6	O [^] 3
52	0	G4	G [^] 2	K4	K [^] 2	O4	O [^] 2
53	0	G2	G [^] 1	K2	K [^] 1	O2	O [^] 1
54	0	G0	G [^] 0	K0	K [^] 0	O0	O [^] 0
55	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
56	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
57	0	H14	H [^] 7	L14	L [^] 7	P14	P [^] 7
58	0	H12	H [^] 6	L12	L [^] 6	P12	P [^] 6
59	0	H10	H [^] 5	L10	L [^] 5	P10	P [^] 5

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
142	1	O0	O ⁰	GX0	GX ⁰	OX0	OX ⁰
143	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
144	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
145	1	P14	P ⁷	HX14	HX ⁷	PX14	PX ⁷
146	1	P12	P ⁶	HX12	HX ⁶	PX12	PX ⁶
147	1	P10	P ⁵	HX10	HX ⁵	PX10	PX ⁵
148	1	P8	P ⁴	HX8	HX ⁴	PX8	PX ⁴
149	1	P6	P ³	HX6	HX ³	PX6	PX ³
150	1	P4	P ²	HX4	HX ²	PX4	PX ²
151	1	P2/GOE1	P ¹	HX2/GOE1	HX ¹	PX2/GOE1	PX ¹
152	1	P0	P ⁰	HX0	HX ⁰	PX0	PX ⁰
153	-	GND	-	GND	-	GND	-
154	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
155	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
156	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
157	-	VCC	-	VCC	-	VCC	-
158	0	A0	A ⁰	A0	A ⁰	A0	A ⁰
159	0	A2/GOE0	A ¹	A2/GOE0	A ¹	A2/GOE0	A ¹
160	0	A4	A ²	A4	A ²	A4	A ²
161	0	A6	A ³	A6	A ³	A6	A ³
162	0	A8	A ⁴	A8	A ⁴	A8	A ⁴
163	0	A10	A ⁵	A10	A ⁵	A10	A ⁵
164	0	A12	A ⁶	A12	A ⁶	A12	A ⁶
165	0	A14	A ⁷	A14	A ⁷	A14	A ⁷
166	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
167	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
168	0	B0	B ⁰	B0	B ⁰	B0	B ⁰
169	0	B2	B ¹	B2	B ¹	B2	B ¹
170	0	B4	B ²	B4	B ²	B4	B ²
171	0	B6	B ³	B6	B ³	B6	B ³
172	0	B8	B ⁴	B8	B ⁴	B8	B ⁴
173	0	B10	B ⁵	B10	B ⁵	B10	B ⁵
174	0	B12	B ⁶	B12	B ⁶	B12	B ⁶
175	0	B14	B ⁷	B14	B ⁷	B14	B ⁷
176	-	VCC	-	VCC	-	VCC	-

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
R14	1	J10	J ⁵	J10	J ⁷	N10	N ⁵	BX10	BX ⁵
P13	1	J12	J ⁶	J12	J ⁸	N12	N ⁶	BX12	BX ⁶
N13	1	J14	J ⁷	J14	J ⁹	N14	N ⁷	BX14	BX ⁷
M12	1	NC	-	NC	-	P4	P ²	FX0	FX ⁰
T15	1	NC	-	NC	-	P6	P ³	FX2	FX ¹
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
-	1	-	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
P14	-	TMS	-	TMS	-	TMS	-	TMS	-
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
L12	1	NC	-	NC	-	NC	-	FX4	FX ²
R16	1	NC	-	NC	-	P8	P ⁴	FX6	FX ³
N14	1	NC	-	NC	-	P10	P ⁵	FX8	FX ⁴
P15	1	K14	K ⁷	K14	K ⁹	O14	O ⁷	CX14	CX ⁷
L11	1	K12	K ⁶	K12	K ⁸	O12	O ⁶	CX12	CX ⁶
P16	1	K10	K ⁵	K10	K ⁷	O10	O ⁵	CX10	CX ⁵
K11	1	K8	K ⁴	K9	K ⁶	O8	O ⁴	CX8	CX ⁴
M14	1	K6	K ³	K8	K ⁵	O6	O ³	CX6	CX ³
K12	1	K4	K ²	K6	K ⁴	O4	O ²	CX4	CX ²
N15	1	K2	K ¹	K4	K ³	O2	O ¹	CX2	CX ¹
N16	1	K0	K ⁰	K2	K ²	O0	O ⁰	CX0	CX ⁰
M15	1	NC	-	K1	K ¹	BX6	BX ³	HX0	HX ⁰
M13	1	NC	-	K0	K ⁰	BX4	BX ²	HX4	HX ¹
-	1	-	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
M16	1	NC	-	NC	-	NC	-	FX10	FX ⁵
L15	1	NC	-	NC	-	P12	P ⁶	FX12	FX ⁶
L16	1	NC	-	NC	-	P14	P ⁷	FX14	FX ⁷
J11	1	NC	-	L14	L ⁹	BX2	BX ¹	HX8	HX ²
K15	1	NC	-	L12	L ⁸	BX0	BX ⁰	HX12	HX ³
J12	1	L14	L ⁷	L10	L ⁷	AX14	AX ⁷	GX14	GX ⁷
K13	1	L12	L ⁶	L9	L ⁶	AX12	AX ⁶	GX12	GX ⁶
K14	1	L10	L ⁵	L8	L ⁵	AX10	AX ⁵	GX10	GX ⁵
K16	1	L8	L ⁴	L6	L ⁴	AX8	AX ⁴	GX8	GX ⁴
J16	1	L6	L ³	L4	L ³	AX6	AX ³	GX6	GX ³
J15	1	L4	L ²	L2	L ²	AX4	AX ²	GX4	GX ²
H16	1	L2	L ¹	L1	L ¹	AX2	AX ¹	GX2	GX ¹
J13	1	L0	L ⁰	L0	L ⁰	AX0	AX ⁰	GX0	GX ⁰
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
-	1	-	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
J14	1	M0	M ⁰	M0	M ⁰	DX0	DX ⁰	JX0	JX ⁰

Lead-Free Packaging**ispMACH 4000Z (Zero Power, 1.8V) Lead-Free Commercial Devices**

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032ZC	LC4032ZC-35MN56C	32	1.8	3.5	Lead-free csBGA	56	32	C
	LC4032ZC-5MN56C	32	1.8	5	Lead-free csBGA	56	32	C
	LC4032ZC-75MN56C	32	1.8	7.5	Lead-free csBGA	56	32	C
	LC4032ZC-35TN48C	32	1.8	3.5	Lead-free TQFP	48	32	C
	LC4032ZC-5TN48C	32	1.8	5	Lead-free TQFP	48	32	C
	LC4032ZC-75TN48C	32	1.8	7.5	Lead-free TQFP	48	32	C
LC4064ZC	LC4064ZC-37MN132C	64	1.8	3.7	Lead-free csBGA	132	64	C
	LC4064ZC-5MN132C	64	1.8	5	Lead-free csBGA	132	64	C
	LC4064ZC-75MN132C	64	1.8	7.5	Lead-free csBGA	132	64	C
	LC4064ZC-37TN100C	64	1.8	3.7	Lead-free TQFP	100	64	C
	LC4064ZC-5TN100C	64	1.8	5	Lead-free TQFP	100	64	C
	LC4064ZC-75TN100C	64	1.8	7.5	Lead-free TQFP	100	64	C
	LC4064ZC-37MN56C	64	1.8	3.7	Lead-free csBGA	56	32	C
	LC4064ZC-5MN56C	64	1.8	5	Lead-free csBGA	56	32	C
	LC4064ZC-75MN56C	64	1.8	7.5	Lead-free csBGA	56	32	C
	LC4064ZC-37TN48C	64	1.8	3.7	Lead-free TQFP	48	32	C
	LC4064ZC-5TN48C	64	1.8	5	Lead-free TQFP	48	32	C
	LC4064ZC-75TN48C	64	1.8	7.5	Lead-free TQFP	48	32	C
LC4128ZC	LC4128ZC-42MN132C	128	1.8	4.2	Lead-free csBGA	132	96	C
	LC4128ZC-75MN132C	128	1.8	7.5	Lead-free csBGA	132	96	C
	LC4128ZC-42TN100C	128	1.8	4.2	Lead-free TQFP	100	64	C
	LC4128ZC-75TN100C	128	1.8	7.5	Lead-free TQFP	100	64	C
LC4256ZC	LC4256ZC-45TN176C	256	1.8	4.5	Lead-free TQFP	176	128	C
	LC4256ZC-75TN176C	256	1.8	7.5	Lead-free TQFP	176	128	C
	LC4256ZC-45MN132C	256	1.8	4.5	Lead-free csBGA	132	96	C
	LC4256ZC-75MN132C	256	1.8	7.5	Lead-free csBGA	132	96	C
	LC4256ZC-45TN100C	256	1.8	4.5	Lead-free TQFP	100	64	C
	LC4256ZC-75TN100C	256	1.8	7.5	Lead-free TQFP	100	64	C

ispMACH 4000Z (Zero Power, 1.8V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032ZC	LC4032ZC-5MN56I	32	1.8	5	Lead-free csBGA	56	32	I
	LC4032ZC-75MN56I	32	1.8	7.5	Lead-free csBGA	56	32	I
	LC4032ZC-5TN48I	32	1.8	5	Lead-free TQFP	48	32	I
	LC4032ZC-75TN48I	32	1.8	7.5	Lead-free TQFP	48	32	I